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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

MATTHIAS BONKAß  
AXEL PREUSSE  
MARKUS NOPPER

Examiner: Luan V. Van

Group Art Unit: 1753

Serial No.: 10/629,106

Att'y Docket: 2000.108300/DE0340

Filed: July 29, 2003

Customer No.: 23720

For: METHOD OF PLATING A  
SEMICONDUCTOR STRUCTURE

**RESPONSE TO OFFICE ACTION DATED SEPTEMBER 7, 2005**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

CERTIFICATE OF MAILING 37 C.F.R. 1.8	
I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date below:	
November 2, 2005 Date	<i>Mary Paul</i> Signature

This paper is submitted in response to the Office Action dated September 7, 2005, for which the three-month date for response is December 7, 2005.

No fees are believed to be due in connection with the present paper. However, should any fees be required under 37 C.F.R. §§ 1.16 to 1.21, the Director is authorized to deduct such fees from the Advanced Micro Devices, Inc. Deposit Account No. 01-0365/DE0340.<sup>1</sup>

Reconsideration of the application in view of the following amendments and remarks is respectfully requested.

<sup>1</sup> In the event the monies in that account are insufficient, the Director is authorized to withdraw funds from Williams, Morgan & Amerson, P.C. Deposit Account No. 50-0786/2000.108300.